



## Summary of GEANT3 Pixel Simulations for Strawman Pixel detector

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# Introduction

- GEANT3 simulation is being used to understand the sensitivity to various design parameters of the pixel detector.
  - IP resolution
    - Relate to this are vertex resolution & proper time resolution
  - Acceptance for selected B decays
- (Too) many variation possible
  - I will show you just the most important ones.
  - Several more in the backup slides

### "Default" Resolution



Slope in reasonable agreement with data (29.7 (G3) vs 30.9 (2010 data)). Material well-simulated.
Intercept in 2010 data (25 μm) vs sim (14.4 μm).
I get 14.2 um, but no vertex error. Vertex errors in 2010 data still too large, but ~20μm. If subtract 20μm in quadrature: σ ~ √25<sup>2</sup>-20<sup>2</sup> ~ 15 μm (close to 14.2 um)

#### VELO

- tuned RF foil to full LHCb sim.
- resolutions from LHCb sim

#### **Pixel**

- ≥23 stations, as in VELO
- ➢ first pixel at 7.5 mm
- 0.5 mm guard ring
- 1% per station
- Outer edge at 34.5 mm (X and Y)
- RF foil X 0.5
- > 150  $\mu$ m thick resol'n function
- > 1 mm overlap btwn L&R halves



# Hole Size

# ResolutionAcceptance

### **Resolution vs Hole Size**



# **Acceptance** Using $B_s \rightarrow D_s(KK\pi)K$

Acceptance measured relative to tracks that have:

- Hit all 3 T-stations
- $|\theta_x| < 350 \text{ mrad}$
- $|\theta_v| < 250 \text{ mrad}$
- $|\theta| > 15 \text{ mrad}$

### Acceptance for $B_s \rightarrow D_s K$

#### Si Coverage: 7.5 mm < |X|, |Y| < 34.5 mm



pseudorapidity spectrum

#### Acceptance comparison: $B_s \rightarrow D_s K$

#### Acceptance definition:

- 3 T hits
- |θ<sub>x</sub>| < 350 mrad
- $|\theta_y| < 250 \text{ mrad}$
- |θ| > 15 mrad

	Acceptance per track (%)		Total 4-body acceptance (%)	
Hole Size	≥3 hits	≥4 hits	≥3 hits	≥4 hits
6.5 mm	99.8	98.0	99.8	96.4
7.5 mm	99.7	97.3	99.5	95.1
8.5 mm	99.4	96.2	98.6	91.5

### **Rotated Planes**

Initial suggestions at VeloPix Kickoff meeting by Tjeerd Ketel (see presentations <u>here</u>)

#### • Pros:

- Clearly sample resolution function closer to minimum, giving better IP resolution.
- Cons
  - Complicates mechanical design
    - Maybe not too much for just rotation around Y axis
  - Pattern recognition/trigger
    - pixel (X,Z) position will depend on X.
  - Improved IP resolution will decrease with radiation dose.
  - Lose some acceptance ~  $\cos\theta_{tilt}$
  - Slightly more material traversed (~ 1/  $\cos\theta_{tilt}$ )
  - If inner region is diamond, charge sharing much less, leading to smaller gains from tilting
- Anyhow, we should have a look at the potential gains & losses.
  - Assume silicon for now
  - No attempt to include decreased hit resolution with rad. dose, although this is something we are interested in doing.

#### Rotated Planes

Y (cm)



#### Angle of track with respect to sensor normal



Assumed resolution function for 150  $\mu$ m thick, non-irradiated silicon.

NB: Binary resolution is ~16 μm

# **IP** Resolution Comparison



# Acceptance comparison with different rotation angles

	Acceptance per track (%)		Total 4-body acceptance (%)	
	≥3 hits	≥4 hits	≥3 hits	≥4 hits
No rotation	99.7	97.3	99.5	95.1
8° fixed rotation	99.6	97.0	99.3	94.3
18° fixed rotation	99.2	95.8	98.6	90.9

# **#Planes/Spacing**

- More closely packed planes means more hits and smaller R of 1<sup>st</sup> hit. I looked at this in the past (25 mm spacing), and it was slightly better, but concern over the tight spacing..
- Worth another look as we start trying to converge!
- Marco G. sent along a suggested layout.
  30 mm spacing → 24 mm spacing, near IP
- No idea how to convincingly model the RF foil for this layout, so I remove it in both the 23 and 26 plane comparisons on next few slides.

### Closer spaced planes 30 mm $\rightarrow$ 24 mm near IP (23 planes $\rightarrow$ 26 planes)



 $<IP_{3D>} = 20.9 \ \mu m + 19.6 \ \mu m / p_T$ 

 $<IP_{3D>} = 18.3 \mu m + 20.6 \mu m / p_T$ 

As one would expect, better resolution as  $1/p_T \rightarrow 0$  since R of 1<sup>st</sup> hit smaller.

Slightly larger slope due to more material.

#### 26 planes a bit better:

NB: But, RF foil large contribution, so hard to conclude just from this.

#### 26 Single Planes vs 13 Doublets



## Acceptance in $B_s \rightarrow D_s K$ 23 pl, 26 pl, 13 doublets

	Acceptance per track (%)		Total 4-body acceptance (%)	
	≥3 hits	≥4 hits	≥3 hits	≥4 hits
23 planes	99.7	97.3	99.5	95.1
26 planes	99.9	99.1	99.8	98.3
13 doublets	99.7	98.3	99.3	96.6



## Vertex Resolution & #Tracks in PV

- Look at minbias events 2e32
  - Run with 6.5 mm, 7.5 mm and 8.5 mm hole
- Compare:
  - Vertex resolution
  - #PV with  $\leq$  5 tracks
- Caveat
  - No rejection of outlier tracks in vertex fit
    - Could probably improve by outlier rejection, but not worth it for this study.
  - Velo tracks, with no T hits, use Kalman errors assuming  $p_T$ =400 MeV
    - Tried more fancy games to do better, but only marginal improvement.



# 'Resolution' vs #Tracks in PV



## Summary

- This is only a small sampling of the many sensitivity tests done. Other targeted, well-motivated scenarios could be tried.
  - See backups.
- All tests though follow your expectation
  - Minimize material before 2<sup>nd</sup> measurement (RF foil dominates)
  - Minimize R of 1<sup>st</sup> Hit
  - Minimize material overall
  - Tilting planes improves resolution (at least at t=0), small acceptance loss for fixed wafer size.
- 26 planes better than 23, at least with respect to acceptance. High p<sub>T</sub> resolution also slightly better, but need to know if significant difference in RF foil x/X<sub>0</sub>.
- Module doublets also give comparable IP resolutions and acceptance to single planes.

## Backups

# Z positions used

23 station geometry - 30 mm spacing (Z positions in cm)

-30.75 -22.75 -16.75 -13.75 -10.75 -7.75 -4.75 -1.75 1.25 4.25 7.25 10.25 13.25 16.25 19.25 22.25 25.25 28.25 44.25 59.25 64.25 69.25 74.25

26 stations – 24 mm spacing geometry (Z positions, in cm)

-30.75 -22.75 -15.9 -13.5 -11.1 -8.7 -6.3 -3.9 -1.5 0.90 3.3 5.7 8.1 10.5 12.9 15.3 17.7 20.1 24.6 30.4 37.9 46.4 59.4 64.4 69.4 74.4

26 stations – 13 doublets geometry (Z positions, in cm)

-30.75 -28.95 -22.75 -20.95 -15.9 -14.1 -10.3 -8.5 -4.7 -2.9 0.9 2.7 6.5 8.3 12.1 13.9 17.7 19.5 24.6 26.4 44.25 46.05 62.45 64.25 72.45 74.25

Negative X modules shifted in Z by 2 mm downstream.

# **Tuning of Material**

VELO –  $B_s \rightarrow \phi \phi$  daughters used here for both



# x/X<sub>0</sub> vs Pseudorapidity, Total

**Full LHCb Simulation GEANT3** Simulation r.I. vs Eta hrlvseta 22.5 20 42626 Entries (%) <sup>(%)</sup> 22 20 3.267 Mean ्र 20 स् 7.5 Mean y 20 12.5 RMS 0.7846 RMS 9.378 15 12.5 10 10 7.5 5 2.5 0 2.5 3.5 4.5 2.5 3.5 4.5 3 4 pseudo-rapidity Pseudorapidity r.l. hrl 42626 Entries 2250 928 2500 Mean 12.37 200 Entries 17127 9.102 RMS 9750 12.31 Mean 2000 RMS 7.876 1500 1250 1000 1000 750 500 500 250 45 x/X<sub>0</sub> (%) 10 15 20 25 40 5 15 25 30 x/X<sub>0</sub>(%) Hard to get the very loooong tail without a more detailed model.

#### New resolution function

150  $\mu$ m silicon thickness



Best resolution at ~20° ~ 350 mrad!

Edge of acceptance

NB: Binary is ~ 16  $\mu$ m

Based on Marcin's Boole implementation

#### Pixel – RF Foil x/X<sub>0</sub> dependence

 $B_s \rightarrow \phi \phi$ , all stable tracks in event.

Module  $x/X_0$  fixed at 1%



#### Resolution in different rapidity ranges

**Minimum Bias Events** 

□ RF Foil  $x/X_0$  scale factor fixed at 0.5 □ Module  $x/X_0$  fixed at 1%



#### Dependence on Pixel module x/X<sub>0</sub>

 $B_s \rightarrow \phi \phi$ , all stable tracks in event.



RF Foil  $x/X_0$  scale factor fixed at 0.5

 $<IP_{3D>} = 18.1 \mu m + 32.9 \mu m / p_T$ 

 $<IP_{3D>} = 17.5\mu m + 30.8\mu m/p_T$ 

 $<IP_{3D>} = 18.0 \mu m + 27.4 \mu m / p_T$ 

 $<IP_{3D>} = 18.0 \mu m + 24.1 \mu m / p_T$ 

#### Hole Geometry – Square vs Round

 $B_s \rightarrow \phi \phi$ , all stable tracks in event.



#### **Dependence on Hit Resolution**

 $B_s \rightarrow \phi \phi$ , all stable tracks in event.



RF Foil  $x/X_0$  scale factor fixed at 0.5 Module fixed at 1%

 $<IP_{3D}$  = 26.2µm+27.1µm/p<sub>T</sub>

 $<IP_{3D>} = 22.7 \mu m + 27.9 \mu m / p_T$ 

 $<IP_{3D>} = 18.0 \mu m + 27.4 \mu m / p_T$ 

 $<IP_{3D} = 13.4 \mu m + 26.8 \mu m / p_T$ 

### Dependence on Guard ring

 $B_s \rightarrow \phi \phi$ , all stable tracks in event.



□ RF Foil  $x/X_0$  scale factor fixed at 0.5 □ Module fixed at 1%

- Minimal effect of guard ring.
- Material before first point dominated by RF foil

# Resolution comparison (Rotation around X&Y axis)



 $<IP_{3D>} = 22.6 \mu m + 28.3 \mu m / p_T$ 

 $<IP_{3D>} = 11.7 \mu m + 26.9 \mu m / p_T$ 

NB: Hit resolution scale factor was 1.25 for this plot, higher than the 1.1 used in the body of this talk.

This is why the intercept is larger.

# Single Planes (Singlets) vs Plane Pairs (Doublets)

# **Pixel Module Doublets**



Build module doublets

- □ More rigid?
- □ Fewer folds → less material traversed?
- □ Maintain Z length of VELO

Different foil than current VELO.

□To compare, remove RF foil from both "standard" 30 mm spacing design, and this one.

# **Plane Spacing details**



Only forward tracks here

Both have 16 planes surrounding IP region

6.2 cm pitch near IP 1.8 cm between two in pair

# # Hits Comparison



# IP resolution (Only rotation around Y axis)



No RF foil in either case, since it's not clear how I should simulate it for doublet scenario.

'Apples & apples' comparison

 $<IP_{3D>} = 19.7\mu m+19.7\mu m/p_T$  $<IP_{3D>} = 18.4\mu m+21.8\mu m/p_T$ 

Slightly better IP resolution for doublets at high  $p_T$ , worse at low  $p_T$  (more hits, more mass)

## Time Resolution $B_s \rightarrow D_s K$



#### Side Check

Do a linear least squares fit, no multiple scattering in error matrix, just hit resolutions. Look at  $\Delta X_{IP}$  to generated production point.



Compare RMS.

Nearly identical for high momentum.

Kalman better at low momentum